

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	NATSUKI TSUNO	09/22/2014
	HIDEYUKI KAZUMI	09/24/2014
	TAKAFUMI MIWA	09/24/2014
	YOSHINOBU KIMURA	09/22/2014
	HAJIME KAWANO	09/26/2014
RECEIVING PARTY DATA		
Name:	Hitachi High-Technologies Corporation	
Street Address:	24-14, Nishishimbashi 1-chome, Minato-ku	
City:	Tokyo	
State/Country:	JAPAN	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14390409
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ATTORNEY DOCKET NUMBER:	XA-12731/T3063-21149US01	
NAME OF SUBMITTER:	SOPHIA L. DAVIS	
SIGNATURE:	/Sophia L. Davis/	
DATE SIGNED:	10/30/2014	
Total Attachments: 1		
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ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ELECTRONIC MICROSCOPE, SETTING METHOD OF OBSERVATION CONDITION OF ELECTRONIC MICROSCOPE, AND OBSERVATION METHOD USING ELECTRONIC MICROSCOPE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) Natsuki Tsuno Natsuki TSUNO

22/9/2014

2) Hideyuki Kazumi Hideyuki KAZUMI

24/9/2014

3) Takafumi Miwa Takafumi MIWA

24/9/2014

4) Yoshinobu Kimura Yoshinobu KIMURA

22/9/2014

5) Hajime Kawano Hajime KAWANO

26/9/2014

6) _____

7) _____

8) _____

9) _____

10) _____
